	A & OA			AO6400 30V N-Channel MOSFET				
General Descripti			Product Sum	nary				
The AO6400 uses adv provide excellent R _{DS(0} with gate voltages as I for use as a load switc	_{>N)} , low gat ow as 2.5V h or in PW	e charge and . This device	l operation is suitable	V_{DS} I_D (at V_{GS} =10V) $R_{DS(ON)}$ (at V_{GS} =10 $R_{DS(ON)}$ (at V_{GS} = 4 $R_{DS(ON)}$ (at V_{GS} = 2	.5V)	30V 6.9A < 28mΩ < 33mΩ < 52mΩ		
Pin1	Bottom View	ana	D [G I			s		
Absolute Maximum Rat	tings I _A =2	5°C unless	otherwise i Symbol			Unite		
	arameter			Maxi	Units V			
Drain-Source Voltage			V _{DS}	3				
Gate-Source Voltage Continuous Drain $T_A=25^{\circ}C$ Current $T_A=70^{\circ}C$ Pulsed Drain Current C			V _{GS} I _D I _{DM}	±12 6.9 5.8 35		A		
Power Dissipation ^B $T_A=25^{\circ}C$			P _D	2 1.3		– w		
Junction and Storage Temperature Range			T_{J},T_{STG}	-55 to 150		°C		
	_							
Thermal Characteristics			0	. 1				
Parameter			Symbol	Тур	Max	Units		
	Iaximum Junction-to-Ambient ^A t ≤ 10s		R _{0JA}	47.5	62.5	°C/W		
Maximum Junction-to-Ambient AD Steady-State				74	110	°C/W		

Maximum Junction-to-Lead

37

50

Steady-State

 $\mathsf{R}_{\theta \mathsf{JL}}$

°C/W



Electrical Characteristics (T₁=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
STATIC F	PARAMETERS						<u> </u>
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V		30			V
	Zero Gate Voltage Drain Current	V_{DS} =30V, V_{GS} =0V				1	A
DSS	Zero Gale Voltage Drain Current	T _J =55°C				5	μA
I _{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±12V				100	nA
V _{GS(th)}	Gate Threshold Voltage	$V_{DS}=V_{GS} I_{D}=250 \mu A$		0.65	1.05	1.45	V
I _{D(ON)}	On state drain current V _{GS} =4.5V, V _{DS} =5V			35			А
R _{DS(ON)} Sta		V _{GS} =10V, I _D =6.9A			18	28	
	Static Drain-Source On-Resistance		T _J =125°C		28	39	mΩ
	Static Drain-Source On-Nesistance	V _{GS} =4.5V, I _D =6A			19	33	mΩ
		V _{GS} =2.5V, I _D =5A			24	52	mΩ
9 _{FS}	Forward Transconductance V _{DS} =5V, I _D =6.9A				33		S
V _{SD}	Diode Forward Voltage	iode Forward Voltage I _S =1A,V _{GS} =0V				1	V
I _s	Maximum Body-Diode Continuous Cur			2	Α		
DYNAMI	C PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =15V, f=1MHz			630		pF
C _{oss}	Output Capacitance				75		pF
C _{rss}	Reverse Transfer Capacitance				50		pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		1.5	3	4.5	Ω
SWITCHI	ING PARAMETERS						
Q _g	Total Gate Charge				6	7	nC
Q _{gs}	Gate Source Charge	V _{GS} =4.5V, V _{DS} =15V, I _D =6.9A			1.3		nC
Q _{gd}	Gate Drain Charge				1.8		nC
t _{D(on)}	Turn-On DelayTime				3		ns
t _r	Turn-On Rise Time	ayTime $R_{GEN}=3\Omega$			2.5		ns
t _{D(off)}	Turn-Off DelayTime				25		ns
t _f	Turn-Off Fall Time				4		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =6.9A, dI/dt=100A/µ	ιS		8.5		ns

A. The value of $R_{n,IA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^{\circ}$ C. The value in any given application depends on the user's specific board design.

B. The power dissipation P_D is based on $T_{J(MAX)}$ =150° C, using \leq 10s junction-to-ambient thermal resistance.

C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150° C. Ratings are based on low frequency and duty cycles to keep initialT₁=25° C.

D. The R_{0JA} is the sum of the thermal impedence from junction to lead R_{0JL} and lead to ambient. E. The static characteristics in Figures 1 to 6 are obtained using <300 μ s pulses, duty cycle 0.5% max.

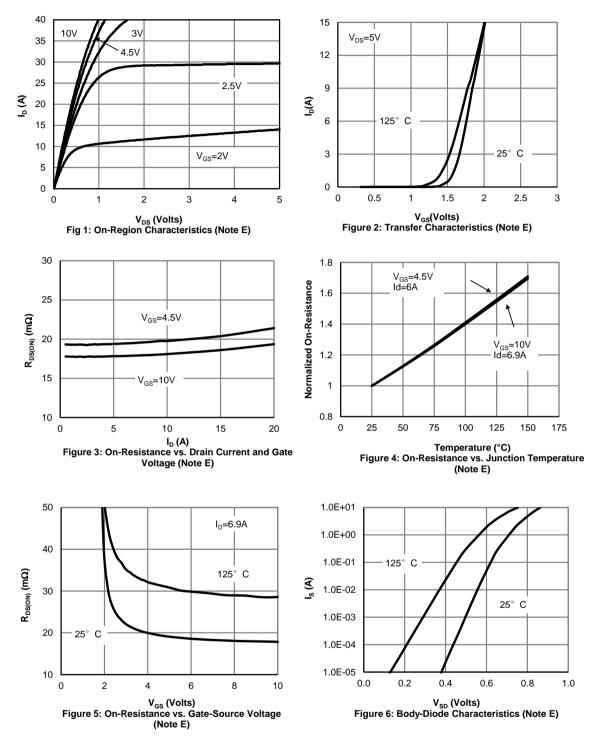
F. These curves are based on the junction-to-ambient thermal impedence which is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, assuming a maximum junction temperature of T_{J(MAX)}=150° C. The SOA curve provides a single pulse rating.

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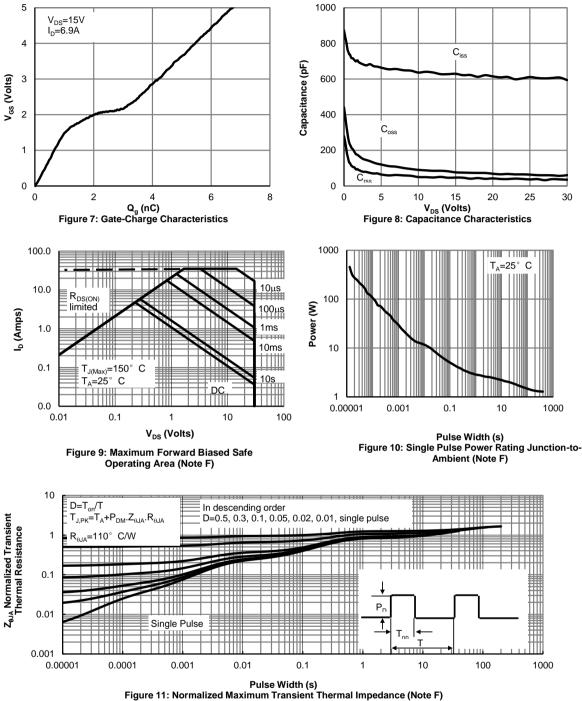


TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





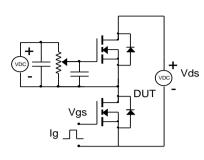
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

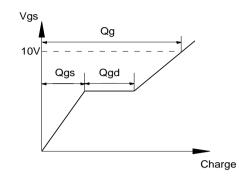




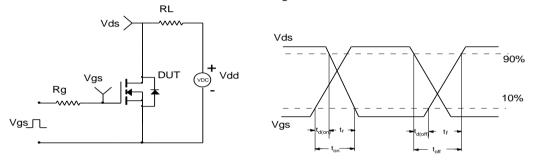


Gate Charge Test Circuit & Waveform





Resistive Switching Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

